

### 描述 / Descriptions

TO-126F 塑封封装 PNP 半导体三极管。Silicon PNP transistor in a TO-126F Plastic Package.

### 特征 / Features

击穿电压高，饱和压降低，开关速度快。

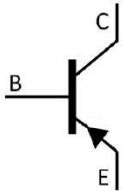
High breakdown voltage, low collector saturation voltage, high speed switching.

### 用途 / Applications

高电压开关转换，小功率开关调节器，直流-直流转换。

High voltage switching, low power switching regulator, DC-DC converter.

### 内部等效电路 / Equivalent Circuit



### 引脚排列 / Pinning



PIN1 : Emitter

PIN 2 : Collector

PIN 3 : Base

### 放大及印章代码 / $h_{FE}$ Classifications & Marking

$h_{FE}$ Classifications Symbol	N	R	O	Y
$h_{FE}$ Range	30~60	40~80	60~120	100~200

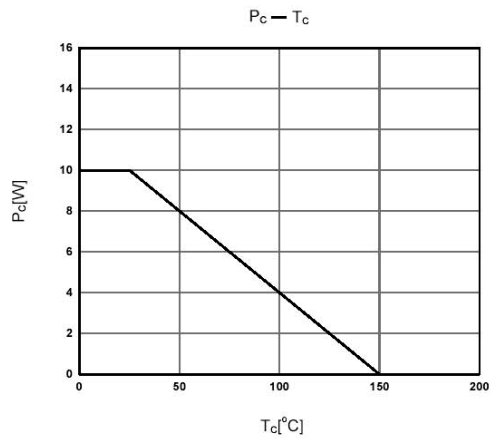
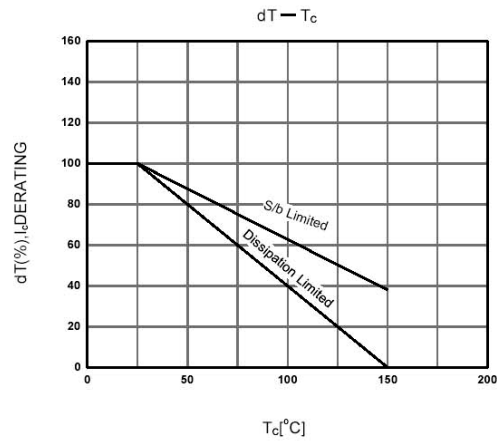
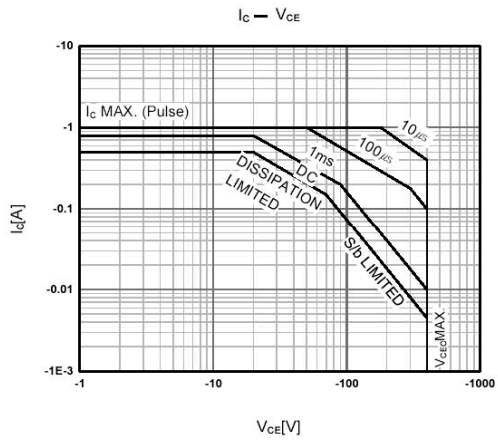
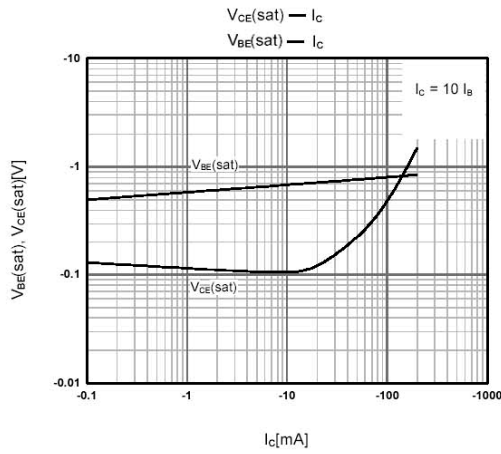
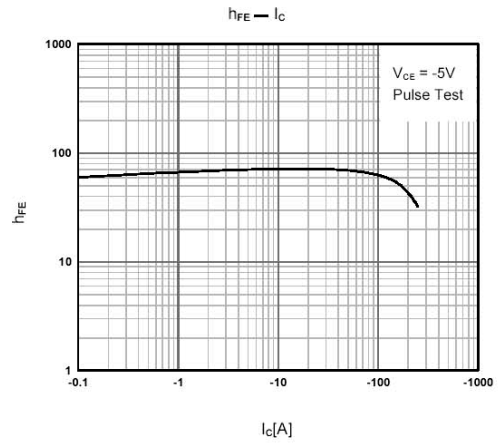
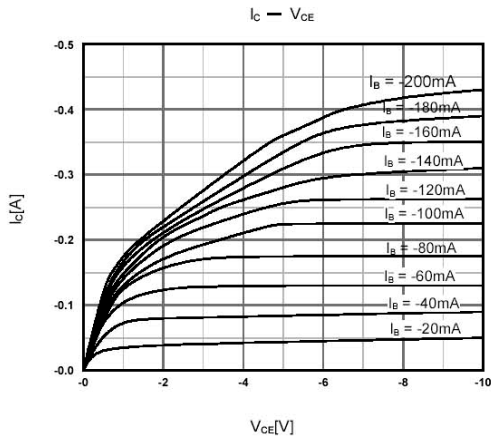
**极限参数 / Absolute Maximum Ratings(Ta=25°C)**

参数 Parameter	符号 Symbol	数值 Rating	单位 Unit
Collector to Base Voltage	$V_{CBO}$	-400	V
Collector to Emitter Voltage	$V_{CEO}$	-400	V
Emitter to Base Voltage	$V_{EBO}$	-7.0	V
Base Current - Continuous	$I_B$	-0.25	A
Collector Current – Continuous	$I_C$	-500	mA
Collector Current – Continuous(Pulse)	$I_{CP}$	-1.0	A
Collector Power Dissipation	$P_C$	1.0	W
Collector Power Dissipation	$P_C(T_c=25^\circ C)$	10	W
Junction Temperature	$T_j$	150	°C
Storage Temperature Range	$T_{stg}$	-55 ~ 150	°C

**电性能参数 / Electrical Characteristics(Ta=25°C)**

参数 Parameter	符号 Symbol	测试条件 Test Conditions	最小值 Min	典型值 Typ	最大值 Max	单位 Unit
Collector-Emitter Sustaining Voltage	$V_{CEO(SUS)}$	$I_C=-100mA$ $I_B=-10mA$ $L=20mH$	-400			V
	$V_{CEX(SUS)}$	$I_C=-200mA$ $V_{BE(off)}=5V$ $I_{B1}=-I_{B2}=-20mA$ $L=10mH$	-400			V
Collector Cut-Off Current	$I_{CBO}$	$V_{CB}=-400V$ $I_E=0$			-100	$\mu A$
Emitter Cut-off Current	$I_{EBO}$	$V_{EB}=-5.0V$ $I_C=0$			-10	$\mu A$
Collector Cut-Off Current	$I_{CEX1}$	$V_{CE}=-400V$ $V_{BE(off)}=1.5V$			-100	$\mu A$
	$I_{CEX2}$	$V_{CE}=-400V$ $T_C=125^\circ C$ $V_{BE(off)}=1.5v$			-1.0	mA
DC Current Gain	$h_{FE}$	$V_{CE}=-5.0V$ $I_C=-100mA$	30		200	
Collector to Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=-100mA$ $I_B=-10mA$			-1.0	V
Base to Emitter Saturation Voltage	$V_{BE(sat)}$	$I_C=-100mA$ $I_B=-10mA$			-1.2	V
Turn On Time	$t_{ON}$	$V_{CC}=-150V$ $I_{B1}=-10mA$ $R_L=1.5K\Omega$ $I_C=-100mA$ $I_{B2}=20mA$			1.0	$\mu S$
Storage Time	$t_{STG}$				4.0	$\mu S$
Fall Time	$t_F$				1.0	$\mu S$

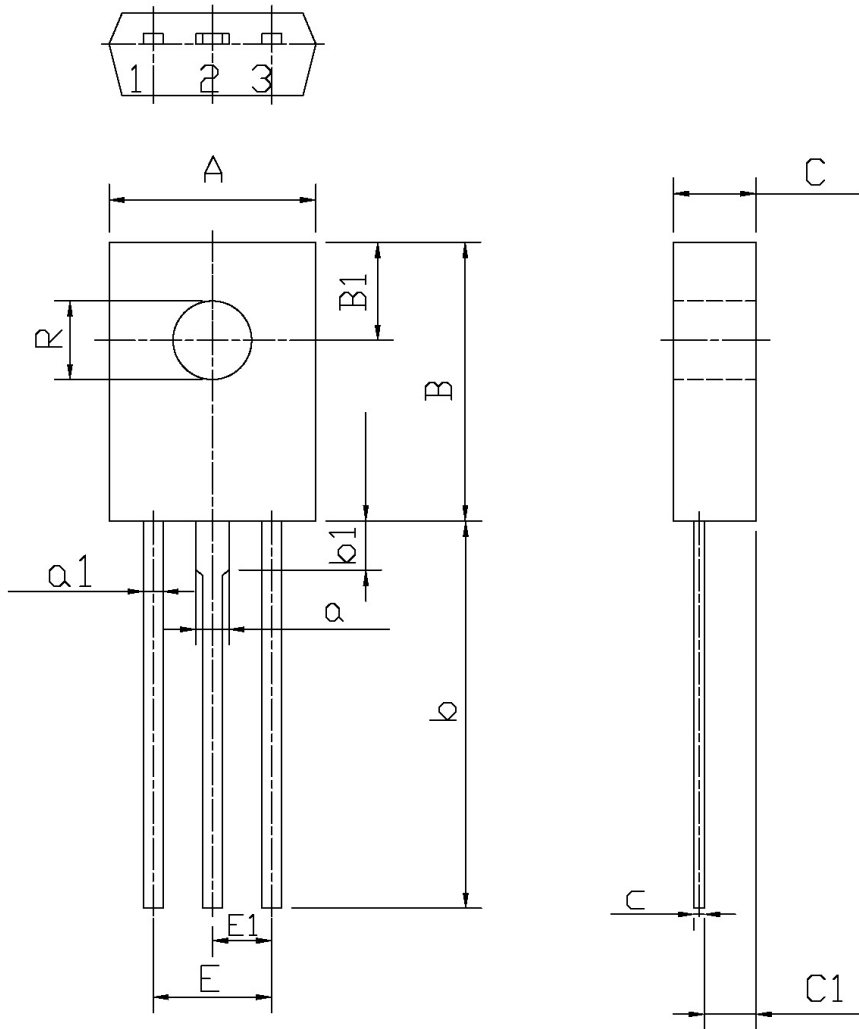
电参数曲线图 / Electrical Characteristic Curve



外形尺寸图 / Package Dimensions

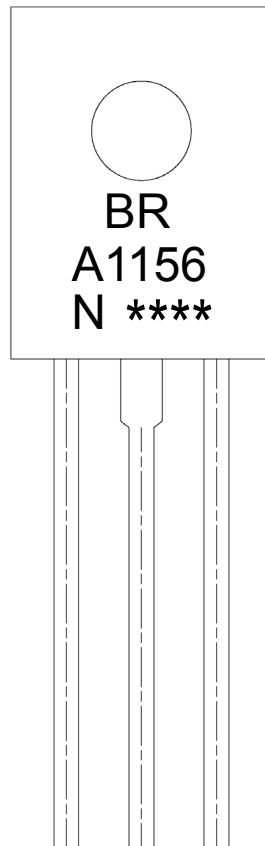
T0-126F

单位: mm



Symbol	Dimensions In Millimeters		Symbol	Dimensions In Millimeters	
	Min	Max		Min	Max
A	7.8	8.2	a1	0.66	0.86
B	10.8	11.2	E	4.4	4.8
B1	3.8	4.2	C	3.1	3.3
R	2.95	3.15	C1	1.9	2.1
b	14	16	c	0.3	0.6
b1	1.9		a	1.27	
E1	2.1	2.5			

**印章说明 / Marking Instructions**



说明：

BR： 为公司代码

A1156： 为型号代码

N： 为  $h_{FE}$  分档代码

\*\*\*\*： 为生产批号代码，随生产批号变化。

Note:

BR: Company Code

A1156: Product Type.

N:  $h_{FE}$  Classifications Symbol

\*\*\*\*: Lot No. Code, code change with Lot No.

**波峰焊温度曲线图(无铅) / Temperature Profile for Dip Soldering(Pb-Free)**



说明：

- 1、预热温度 25 ~ 150°C，时间 60 ~ 90sec;
- 2、峰值温度 255±5°C，时间持续为 5±0.5sec;
- 3、焊接制程冷却速度为 2 ~ 10°C/sec.

Note:

- 1.Preheating:25~150°C, Time:60~90sec.
- 2.Peak Temp.:255±5°C, Duration:5±0.5sec.
3. Cooling Speed: 2~10°C/sec.

**耐焊接热试验条件 / Resistance to Soldering Heat Test Conditions**

温度：270±5°C

时间：10±1 sec.

Temp.:270±5°C

Time:10±1 sec

**包装规格 / Packaging SPEC.**

散件包装 / BULK

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm <sup>3</sup> )		
	Units/Tube 只/套管	Tubes/Inner Box 套管/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Tube 套管	Inner Box 盒	Outer Box 箱
TO-126/F	500	6	3,000	5	15,000	135×190	237×172×102	560×245×195

套管包装 / TUBE

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm <sup>3</sup> )		
	Units/Tube 只/套管	Tubes/Inner Box 套管/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Tube 套管	Inner Box 盒	Outer Box 箱
TO-126/F	65	26	1,690	5	8,450	532×31×5.6	555×164×50	575×290×180

**使用说明 / Notices**